



PART NUMBER CODING

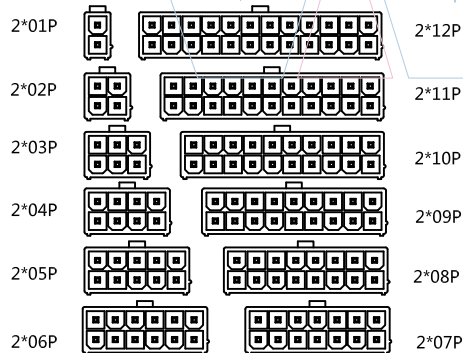
W42002-2 XX R XX X X 1

No. of pins
01-12P

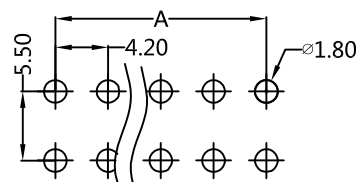
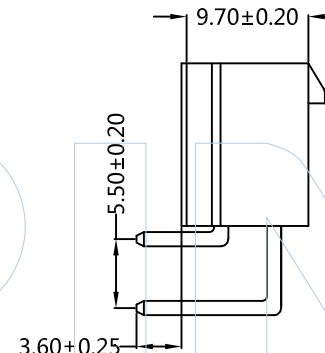
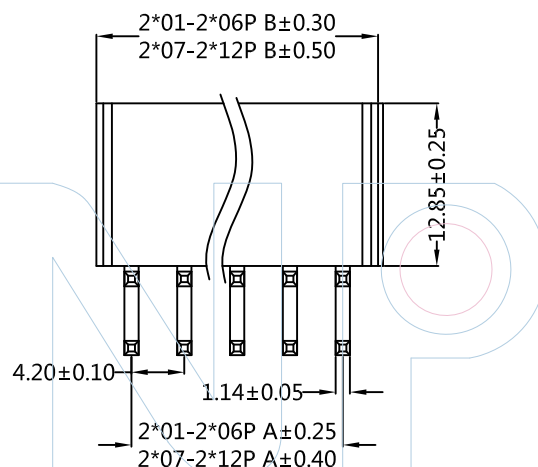
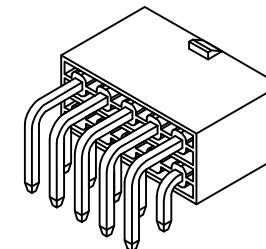
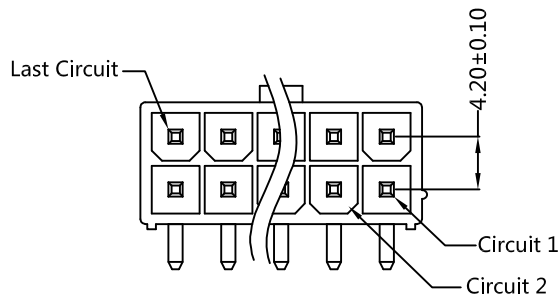
Contact plating
G0:Gold Flash
G1:3U"Gold
G2:5U"Gold
G3:10U"Gold
G4:15U"Gold
G5:20U"Gold
G6:30U"Gold
S0:Gold Flash/Tin
S1:3U"Gold/Tin
S2:5U"Gold/Tin
S3:10U"Gold/Tin
S4:15U"Gold/Tin
S6:30U"Gold/Tin
SN:Tin

Color
W=White
B=Black

Packing
A=Tray
B=PE Bag



CIRCUIT SIZE LAYOUT



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

Pins	Dimensions	
	A	B
2x01	--	5.60
2x02	4.20	9.80
2x03	8.40	14.00
2x04	12.60	18.20
2x05	16.80	22.40
2x06	21.00	26.60
2x07	25.20	30.80
2x08	29.40	35.00
2x09	33.60	39.20
2x10	37.80	43.40
2x11	42.00	47.60
2x12	46.20	51.80



Tel:+86 769 82581808
E-Mail:sales@winpin.net

FAX:+86 769 81766192
Http:www.winpin.net

PART NO: W42002-2XXRXXX1

TITLE: 4.20 Wafer Dual ROW 90° DIP

NOTES:

Current Rating:7AMP
VoltageRating: 600V AC/DC
Withstand Voltage:1500V AC/Minute
Contact Resistance:20mΩ Max
Insulation Resistance:1000MΩ Min
Operation Temperature:-25℃~+85℃
Applicable Housing:H42002 Series
Applicable Terminal:T42002 Series

MATERIAL:

Contact Material: Brass
Contact Plating:Au or Sn over Ni
Insulator Material:PA66(UL94V-2)

UNLESS OTHERWISE
SPECIFIED DIMENSIONS
ARE IN METRIC

TOLERANCES ARE:
DECIMALS Angle
X.X:±0.40 ± 3°
X.XX:±0.25
X.XXX:±0.15

SCALE 1:1
UNIT MM
PROJ.
SHEET

A0	2015/06/25	NEW	Hua.ZT		Hua.ZT
REV	DATE	MODIFICATION DESCRIPTION	DRAW	CHANGE	APPROVE